

December 1994

LM380 Audio Power Amplifier

General Description

The LM380 is a power audio amplifier for consumer application. In order to hold system cost to a minimum, gain is internally fixed at 34 dB. A unique input stage allows inputs to be ground referenced. The output is automatically self centering to one half the supply voltage.

The output is short circuit proof with internal thermal limiting. The package outline is standard dual-in-line. A copper lead frame is used with the center three pins on either side comprising a heat sink. This makes the device easy to use in standard p-c layout.

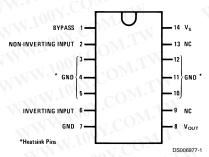
Uses include simple phonograph amplifiers, intercoms, line drivers, teaching machine outputs, alarms, ultrasonic drivers, TV sound systems, AM-FM radio, small servo drivers, power converters, etc.

A selected part for more power on higher supply voltages is available as the LM384. For more information see AN-69.

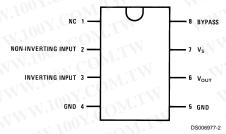
Features

- Wide supply voltage range
- Low quiescent power drain
- Voltage gain fixed at 50
- High peak current capability
- Input referenced to GND
- High input impedance
- Low distortion
- Quiescent output voltage is at one-half of the supply voltage
- Standard dual-in-line package

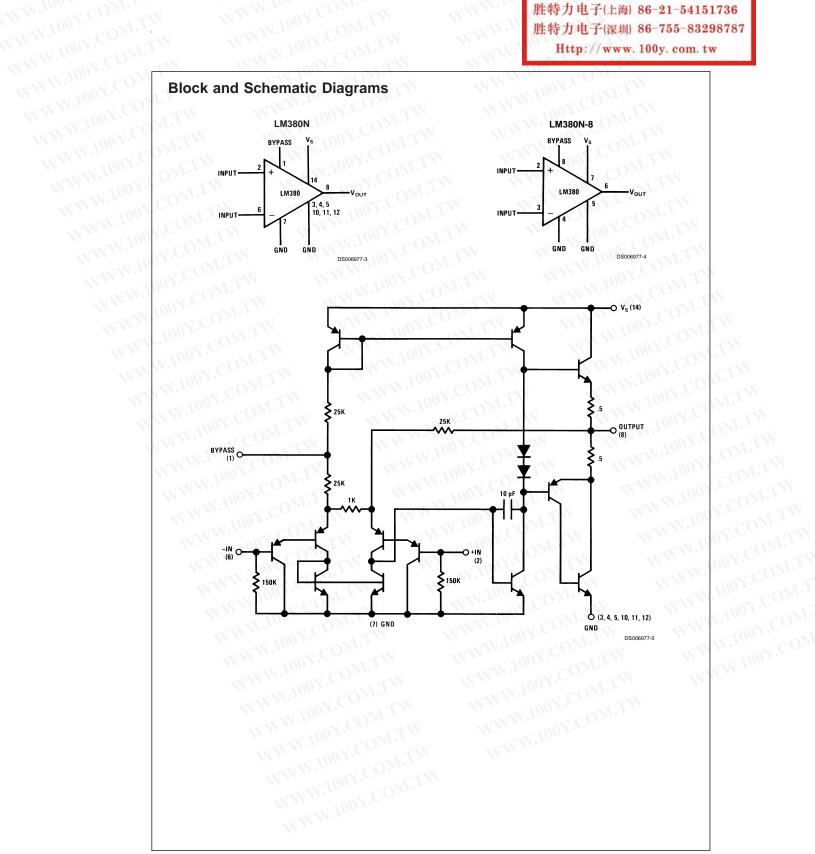
Connection Diagrams (Dual-In-Line Packages, Top View)



Order Number LM380N See NS Package Number N14A



Order Number LM380N-8 See NS Package Number N08E



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If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications. Supply Voltage Peak Current Package Dissipation 14-Pin DIP (Note 7) Package Dissipation 8-Pin DIP (Note 7) Package Dissipation 8-Pin DIP (Note 7) Package Dissipation 14-Pin DIP (Note 7) Package Dissipation 8-Pin DIP (Note 7)	MYW.100		胜特力电子	F(上海) 86-21 F(深圳) 86-75 Www. 100y.
Distributors for availability and specifications.ESD rating to be determinedSupply Voltage22VThermal ResistancePeak Current1.3A θ_{JC} (14-Pin DIP)30°C.Package Dissipation 14-Pin DIP (Note 7)8.3W θ_{JC} (8-Pin DIP)37°C.Package Dissipation 8-Pin DIP (Note 7)1.67W θ_{JA} (14-Pin DIP)79°C.Input Voltage $\pm 0.5V$ θ_{JA} (8-Pin DIP)107°C.	If Military/Aerospace specified device	s are required,	Junction Temperature	0°C to +70° +150°
Supply Voltage 22V Thermal Resistance Peak Current 1.3A θ_{JC} (14-Pin DIP) 30°C. Package Dissipation 14-Pin DIP (Note 7) 8.3W θ_{JC} (8-Pin DIP) 37°C. Package Dissipation 8-Pin DIP (Note 7) 1.67W θ_{JA} (14-Pin DIP) 79°C. Input Voltage ± 0.5 V θ_{JA} (8-Pin DIP) 107°C.	10 / 10 / 10 / 10 / 10 / 10 / 10 / 10			+260°
	Peak Current Package Dissipation 14-Pin DIP (Note 7) Package Dissipation 8-Pin DIP (Note 7) Input Voltage	1.3A 8.3W 1.67W ±0.5V	Thermal Resistance θ_{JC} (14-Pin DIP) θ_{JC} (8-Pin DIP) θ_{JA} (14-Pin DIP)	30°C/\ 37°C/\ 79°C/\ 107°C/\

Electrical Characteristics (Note 2)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
P _{OUT(RMS)}	Output Power	$R_L = 8\Omega$, THD = 3% (Notes 4, 5)	2.5	WW	4.0	W
A _V	Gain	LAW. Too. COM.	40	50	60	V/V
V _{OUT}	Output Voltage Swing	$R_L = 8\Omega$		14	_ 1	V_{p-p}
Z _{IN}	Input Resistance	TIMM. TO COME	N	150k	MAI.	Ω
THD	Total Harmonic Distortion	(Notes 5, 6)		0.2	TVI	%
PSRR	Power Supply Rejection Ratio	(Note 3)		38	144.	dB
Vs	Supply Voltage	TAIN. TO COM.	10		22	V
BW	Bandwidth	$P_{OUT} = 2W, R_L = 8\Omega$	1.11	100k	14.	Hz
la	Quiescent Supply Current	MININ.	- TW	7	25	mA
V _{OUTQ}	Quiescent Output Voltage	100 CO	8	9.0	10	V
I _{BIAS}	Bias Current	Inputs Floating	TI	100		nA
I _{sc}	Short Circuit Current	TANN. TO CC	IAT.	1.3	- 1	Α

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 2: $V_S = 18V$ and $T_A = 25^{\circ}C$ unless otherwise specified.

Note 3: Rejection ratio referred to the output with $C_{\mbox{\footnotesize{BYPASS}}}$ = 5 $\mu\mbox{\footnotesize{F}}.$

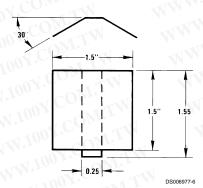
Note 4: With device Pins 3, 4, 5, 10, 11, 12 soldered into a 1/16" epoxy glass board with 2 ounce copper foil with a minimum surface of 6 square inches.

Note 5: $C_{BYPASS} = 0.47 \mu fd$ on Pin 1.

Note 6: The maximum junction temperature of the LM380 is 150°C.

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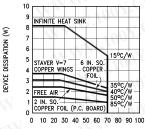
Heat Sink Dimensions



Staver Heat Sink #V-7 Staver Company 41 Saxon Ave. P.O. Drawer H Bayshore, NY 11706 Tel: (516) 666-8000 Copper Wings 2 Required Soldered to Pins 3, 4, 5, 10, 11, 12 Thickness 0.04 Inches

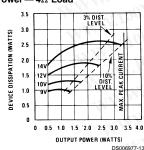
Typical Performance Characteristics

Maximum Device Dissipation vs Ambient Temperature

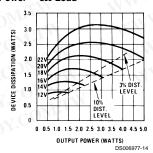


T_A- AMBIENT TEMPERATURE (°C)
Note: 2 oz. copper foil, single-sided PC board.

Device Dissipation vs Output Power — 4Ω Load



Device Dissipation vs Output Power — 8Ω Load

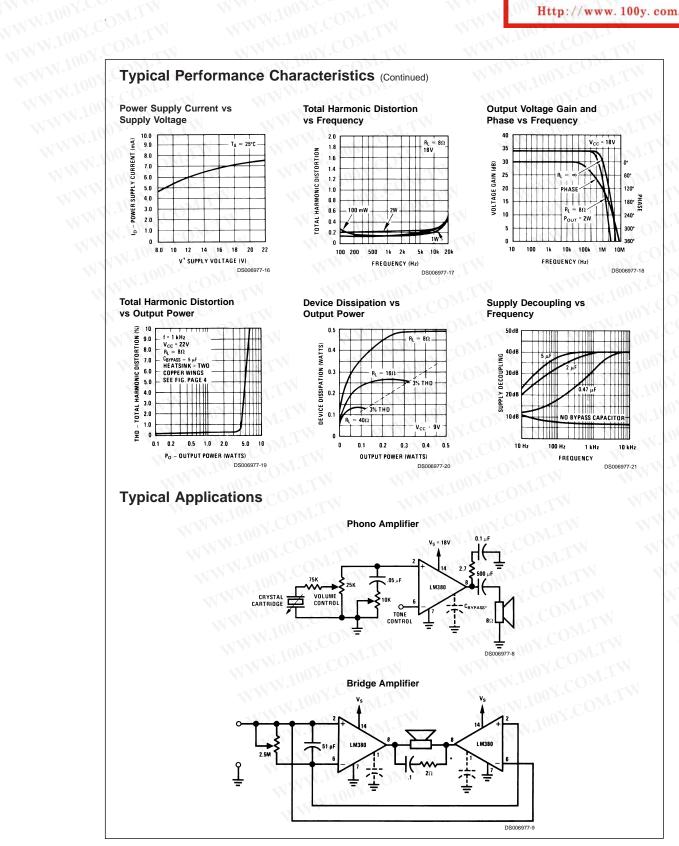


Device Dissipation vs Output Power — 16Ω Load

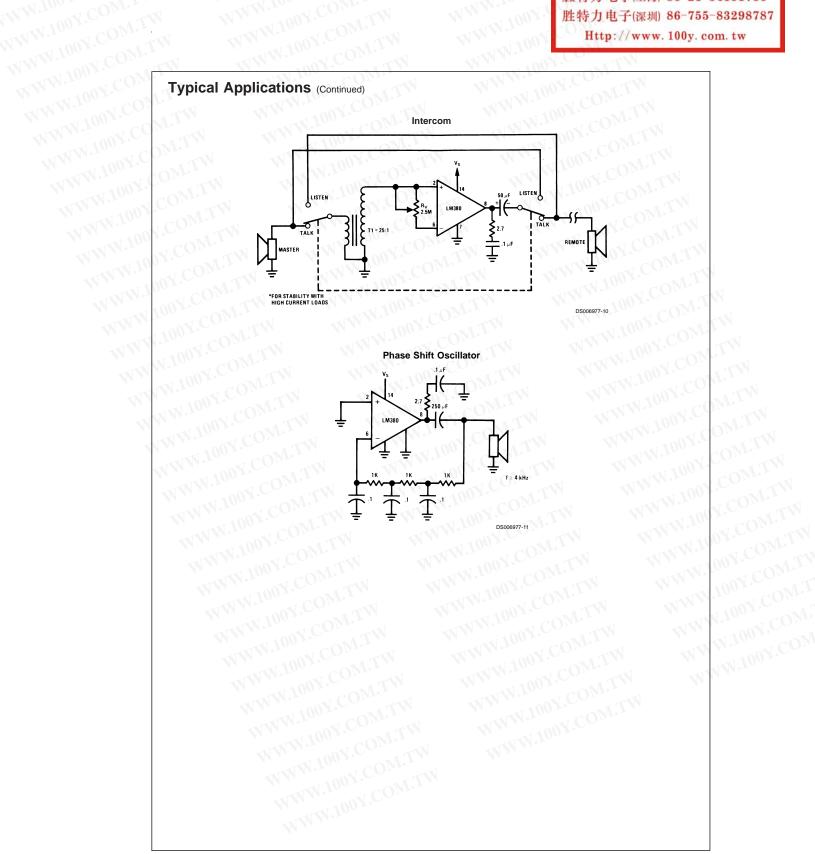


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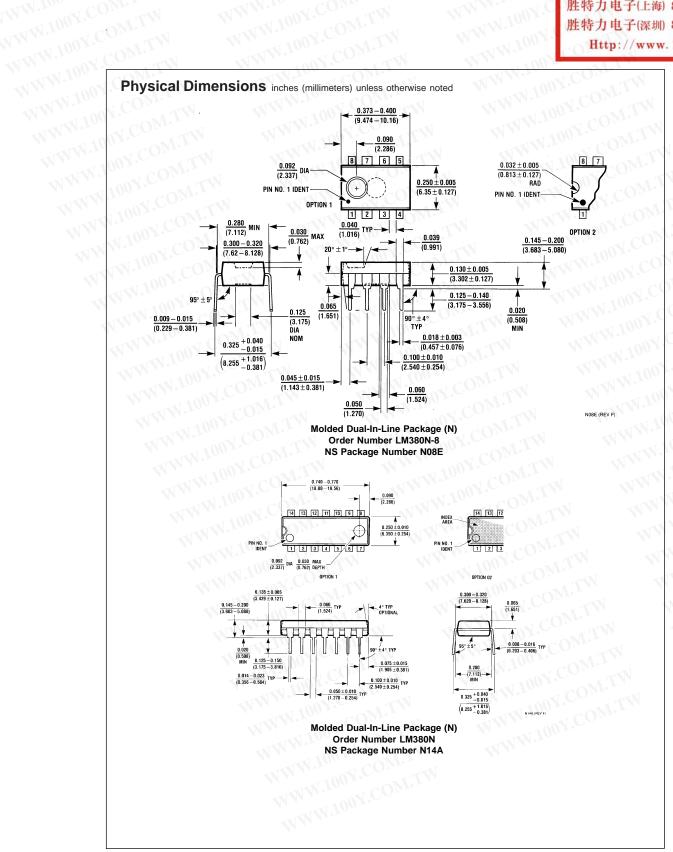
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Notes

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